Thread-Lok<sup>™</sup> 27



# High-Temp Anaerobic Vibration Resistant Thread-locker

# **PRODUCT DESCRIPTION**

Incure Thread-Lok<sup>™</sup> 27 is a single component, high-temp grade anaerobic thread-locker designed for devices subjected to movements. Its shock and vibration absorption capability prevents leakages resulting from loosening of threaded fasteners. Thixotropic in form, it is ideal for filling gaps of up to 20 to 50um. Incure Thread-Lok<sup>™</sup> 27 can be used for many types of surfaces and subjected to temperature range (-55°C to 150°C) where ease of disassembly work is necessary from time to time, such as repair and maintenance work. Meets Mil S-46163A for military requirements.

### UNCURED PROPERTIES

Chemical Type	Dimethacrylate Ester			
Appearance	Clear Blu	e		
Density, g/ml	1.06	Flash Point	> 93°C ( > 200°F)	
Viscosity, cP (rpm)	20	2,200 - 3,000	Spindle	3
Other viscosities are a viscosity range request this product may be p Email us at: support@ local distributor for mo	ASTM	D2556		

Viscosity (cP) taken at 25°C (77°F) - Call to enquiry for other viscosities.

### SET / FULL CURE TIME ON MATERIALS

MATERIAL	SET TIME	FULL CURE TIME
Steel	12 min	24 hr
Brass	12 min	24 hr
Zinc-Plated	15 min	24 hr
Stainless Steel	15 min	24 hr

### **CURED PROPERTIES**

Service	-55°C to 150°C	
Temperature	(-67°F to 302°F)	

### MAXIMUM TORQUE

Working	5.0 N-m (44.3 in-lbs)
Breakaway	13.8 N-m (122.1 in-lbs)

#### Incure Inc.

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# SHELF-LIFE, STORAGE, USE AND HANDLING

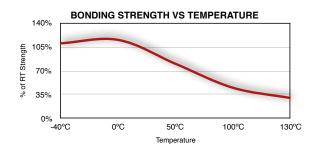
Shelf-Life of this unopened product is a minimum of 12 mths from date of manufacture. Avoid direct exposure of bottle to visible light at all times. Containers should remained covered when not in use. Product should be stored 15°C to 25°C (59°F to 77°F). Transfer of product into other packages void all warranties. Users should ensure all bonding surfaces are free of grease, mold release, or any contaminants, as bonding performance will be compromised. Dispense only to one surface only. Bonding parts should be carried out at ambient temperature. For safe handling of this product, please read Material Safety Data-sheet (MSDS) prior to use. Organic solvents, such as IPA, may be used to wipe away uncured material from surfaces.

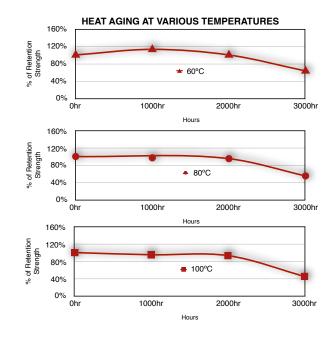
# EtO and GAMMA STERILIZATION (Not Applicable)

All Incure Medical products are formulated to subject to standard sterilization methods, such as EtO and Gamma Radiation of 25 to 50 kGrays (cumulative). Enhanced moisture and thermal resistance of this product show excellent adhesion and bonding strength after one cycle of steam auto-clave test. Depending on bond design and structure of the application, users should test specific assemblies after subjecting them to the test requirements. Please consult Incure Support Team for assistance, if your devices are subjected to more than one sterilization cycles.

### NOTE

The data contained in this document are furnished for information only. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein. INCURE will not be liable for any indirect, special, incidental or consequential loss or damage arising from this INCURE product, regardless of the legal theory asserted. INCURE recommends that each user adequately test its proposed use and application before repetitive use, using this data as a guide.





### SOLVENT RESISTANCE TABLE

Alcohol	Ethanol, Methanol	Good
Aromatic Ester	Ethylacetate	Poor
Aromatic Ketones	Acetone, Benzophenone	Poor
Alkanes, Aliphatic Hydrocarbons	Petrol, Heptanes, Hexane	Fair
Alkanes, Aromatic Hydrocarbons	Benzyl, Toluol, Xylol	Fair
Halogenated Hydrocarbons	Methylenchloride	Poor
Thatogenated Trytrocarbons	Cholorobenzol	Poor
A susses A sid Mask	Nitrite, Sulphuric, Phosphoric Acid (Weak)	Good
Aqueous Acid, Weak	Nitrite,Sulphuric, Phosphoric Acid (Concentrated)	Poor
Aqueous Base, Weak	Sodium Hydroxide Solution, Caustic Potash (Weak)	Good
	Sodium Hydroxide Solution, Caustic Potash (Concentrated)	Poor